PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MENG WANG	11/26/2019
JIGNESH BHADALIYA	11/25/2019
MIN GONG	11/26/2019
XIN WU	11/22/2019
MINGLONG SUN	11/28/2019

RECEIVING PARTY DATA

Name: EMC IP HOLDING COMPANY LLC		
Street Address:	176 SOUTH STREET	
City:	HOPKINTON	
State/Country:	MASSACHUSETTS	
Postal Code: 01748		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16731335

CORRESPONDENCE DATA

Fax Number: (216)696-8731

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 216-696-8730

Email: epas@thepatentattorneys.com **Correspondent Name:** AMIN, TUROCY & WATSON, LLP

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Address Line 2: SUITE 300

Address Line 4: BEACHWOOD, OHIO 44122

Total Attachments: 7		
DATE SIGNED: 12/31/2019		
SIGNATURE:	/Patrica S. Murphy/	
NAME OF SUBMITTER:	ME OF SUBMITTER: PATRICA S. MURPHY	
ATTORNEY DOCKET NUMBER:	116617.01/DELLP317US	

Total Attachments: 7

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PATENT/Joint Assignment EMC Docket No.: 116617.01

ASSIGNMENT

WHEREAS, we, Meng Wang, Jignesh Bhadaliya, Min Gong, Xin Wu, and Minglong Sun have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled *FACILITATING A SMART WATCH LIST WITH LIMITED RESOURCES IN STORAGE SYSTEMS*, the specification of which:

[X]	is being executed on even date herewith and States Patent Office;	is about to be filed in the United
[]	was filed on as U.S. Ap	pplication No;
[]	was patented under U.S. Patent No.	on

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the State of Delaware and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein:

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution,

PATENT/Joint Assignment EMC Docket No.: 116617.01

reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

PATENT/Joint Assignment EMC Docket No.: 116617.01

Date: Nov. 22aad, 2019	Meng Wang
·	Inventor's Signature
Print full name of second inventor:	Meng Wang
Residence:	Shanghai, China
Citizenship:	China
Mailing Address:	Floor 5, Building 1, No 252 Songhu Road, Yangpu District, Shanghai, China
I Y' Shang (name) whose residential address is Was personally present and did see (name) whose residential address is was personally present and did see (name) whose residential address is was personally present and did see (name) of person signing the assignment) who is personally known to medexecute the above assignment. (signature of first witness) Signed at (Jo 244 Sougha Roal (location of witness signature) on this day (Vovember 26 of 20 1) (date of signature)	
	name) whose residential address is U. Shangha (name of person signing de, execute/the above assignment. gnature of second witness) (location of witness signature)

PATENT/Joint Assignment EMC Docket No.: 116617.01

Date: NUV. 25, 2019	Sign
	Inventor's Signature
Print full name of second inventor:	Jignesh Bhadaliya
Residence:	Irvine, California
Citizenship:	United States
Mailing Address:	10 Solstice Irvine, CA 92602
I Jossh Coladness Rancho M:55:00 Vicjo, C was personally present and did see Jig the assignment) who is personally known	(name) whose residential address is 157 Jariful C.v. Saliforn: a DES L. Bhadaliyh (name of person signing to me, execute the above assignment.
11/2 / Ida	_ (signature of first witness)
	_ (signature of first witness)
Signed at Missin Vinjo, CA	(location of witness signature)
on this day November 25 c	of 20 <u>19</u> . (date of signature)
I BRIAN YAMADA B SOLSTICE IRVINE	ca 92602
was personally present and did see	nesh Bhdaligh (name of person signing to me, execute the above assignment.
	(signature of second witness)
Signed at 8 SOUSTICE KRYINE	(location of witness signature)
on this day NoV 25 o	f 20 <u>19</u> . (date of signature)

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PATENT/Joint Assignment EMC Docket No.: 116617.01

Nov. 12nd, 2019	Min Grong.
1	Inventor's Signature
Print full name of second inventor:	Min Gong
Residence:	Shanghai, China
Citizenship:	China
Mailing Address:	Room 402, No. 6, Lane 820, Quyang Road Shanghai, 200437 China
was personally present and did see	in (Inve. (name of person signing
the assignment) who is personally known to	ne, execute the above assignment.
4: Shany (si	gnature of first witness)
	gimento of first without
Signed at Works Koart (location of witness signature)
Signed at November 26 of 20	0 <u>19</u> . (date of signature)
, , ,	1
NO 224 Sonahu RD. Yango	name) whose residential address is U. Shanghai
was personally present and did see	(name of person signing
the assignment) who is personally known to r	ne, execute the above assignment.
<u>Jenny Chen</u> (si	gnature of second witness)
Signed at No 234 Songhu Roa	(location of witness signature)
on this day November 26 of 26	O 1 (date of signature)

Date: Nov. 22, 2019	Xin Wu
	Inventor's Signature
Print full name of first inventor:	Xin Wu
Residence:	Shanghai, 200120 China
Citizenship:	China
Mailing Address:	Shangcheng Road Lane 1028 Room 402 Shanghai, 200120 China
I Lingthow Thans Was personally present and did see Lingth the assignment) who is personally known to the assignment of the second transfer of the second trans	me, execute the above assignment.
Linkhon Thank (s	ignature of first witness)
Signed at Something Rd 202	(location of witness signature)
Lingthon Thanf (s Signed at Songthong Rel 202 (on this day Nov 22nd of 2	0 (date of signature)
Nancola Rd 901, 28# 501	(name) whose residential address is //// (name of person signing
was personally present and did seeXin the assignment) who is personally known to	
	ignature of second witness)
Signed at Sorghu Rd 252 on this day Nov 22rd of 2	(location of witness signature)
on this day Nov 22nd of 2	0/9. (date of signature)

Date 2/1//1/19	_ MINCLONE SAN	
	Inventor's Signature	
Print tall name of second inventor	Minglong Sun	
Residence	Shanghai, China	
Citizenship	China	
Maring Address	Floor 5, Building 1 No 252 Songhu Road, Yangpu District, Shanghai, China	
	(name) whose residential address is	
was personally present and did see the assignment who is personally kno	name of person signing witto me, execute the above assignment.	
	(signature of first winess)	
Signed at	(location of wimess signature)	
on this day	_ of 20 (date of signature)	
was personally present and did see the assignment who is personally kno	thame of person signing on to me, execute the above assignment.	
	(signature of second witness)	
Signed at	(location of witness signature)	
on this day	_of 20 (date of signature)	

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